

**Vishay Siliconix** 

RoHS

COMPLIANT HALOGEN

Available

## N-Channel 12-V (D-S) MOSFET

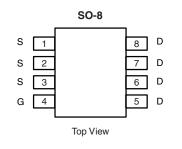
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
	0.0053 at V <sub>GS</sub> = 4.5 V	21.5				
12	0.006 at V <sub>GS</sub> = 2.5 V	20.2	29.5 nC			
	0.0074 at V <sub>GS</sub> = 1.8 V	18.2				

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

#### **APPLICATIONS**

- Synchronous Rectifier
- Point-of-Load Synchronous Buck Converter



Ordering Information: Si4866BDY-T1-E3 (Lead (Pb)-free) Si4866BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	12			
Gate-Source Voltage		V <sub>GS</sub>			± 8
	T <sub>C</sub> = 25 °C		21.5		
Continuous Drain Current (T = $150 ^{\circ}$ C)	T <sub>C</sub> = 70 °C	1-	17.2		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	16.1 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		12.9 <sup>b,c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	50	A	
Orational David Divide Oracet	T <sub>C</sub> = 25 °C	L.	4.0		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.3 <sup>b,c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20		
Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		4.45	w	
Movimum Dower Dissinction	T <sub>C</sub> = 70 °C	P	2.85		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.50 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		1.6 <sup>b,c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b,d</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	23	28	0/10		

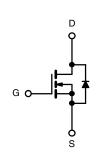
Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 90 °C/W.



N-Channel MOSFET

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						I	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	12			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 250		12		m)//0C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 3.5		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.4		1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
	I <sub>DSS</sub>	V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V			1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = 12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A		0.0042	0.0053		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 10 A	=		0.0060	Ω	
	-()	V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 8 A		0.006	0.0074	1	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 12 A		80		S	
Dynamic <sup>b</sup>				1	1	1	
Input Capacitance	C <sub>iss</sub>			5020			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1305		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			805			
		V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		52	80	<u> </u>	
Total Gate Charge	Qg			29.5	45	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 6 V, V_{GS} = 2.5 V, I_{D} = 10 A$		6.2			
Gate-Drain Charge	Q <sub>gd</sub>			8.9			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.8	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			26	40		
Rise Time	t <sub>r</sub>	$V_{DD} = 6 V, R_1 = 1.2 \Omega$		18	30	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$		85	130		
Fall Time	t <sub>f</sub>	, i i i i i i i i i i i i i i i i i i i		32	50	ĺ	
Turn-On Delay Time	t <sub>d(on)</sub>			13	25	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 6 V, R_1 = 1.2 \Omega$		12	24	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		57	90		
Fall Time	t <sub>f</sub>	Ť		9	18	ĺ	
Drain-Source Body Diode Characteristi	cs			I			
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C		4			
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			1	50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.3 A		0.62	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		50	80	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			35	55	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	- I <sub>F</sub> = 9.5 A, dI/dt = 100 A/µs, T <sub>J</sub> = 25 °C		19			
Reverse Recovery Rise Time	t <sub>b</sub>			31		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

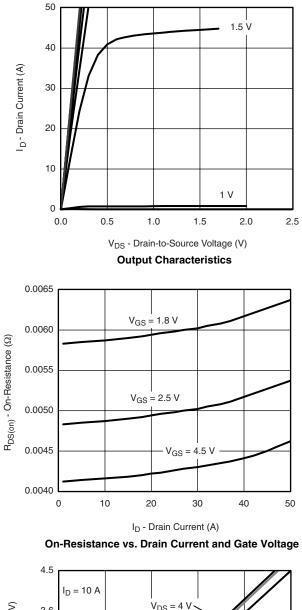
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

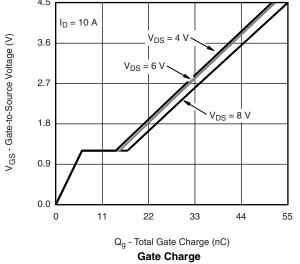


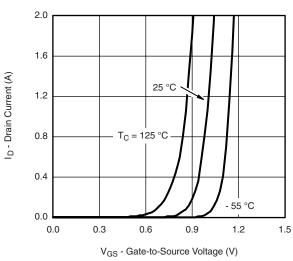
## Si4866BDY

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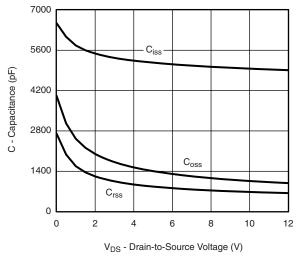




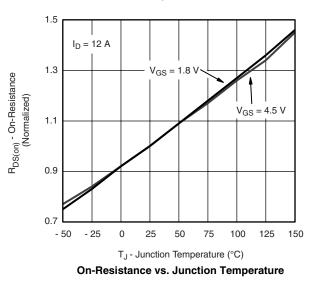




**Transfer Characteristics** 



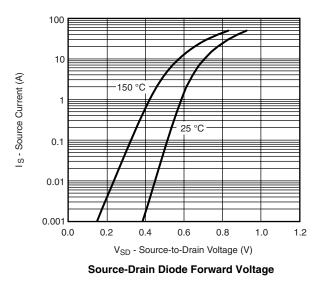


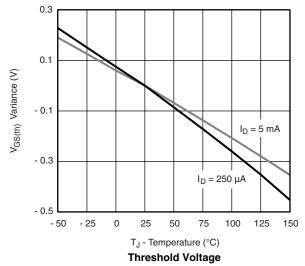


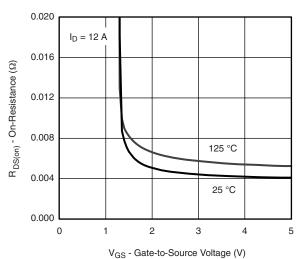
Document Number: 70341 S09-0540-Rev. B, 06-Apr-09

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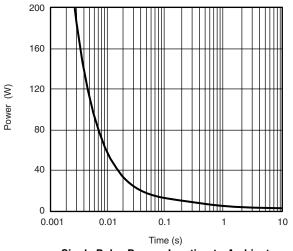
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

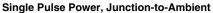


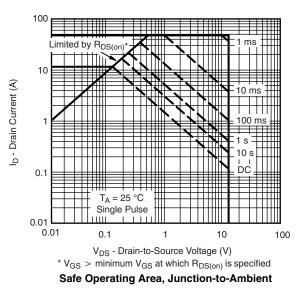




On-Resistance vs. Gate-to-Source Voltage

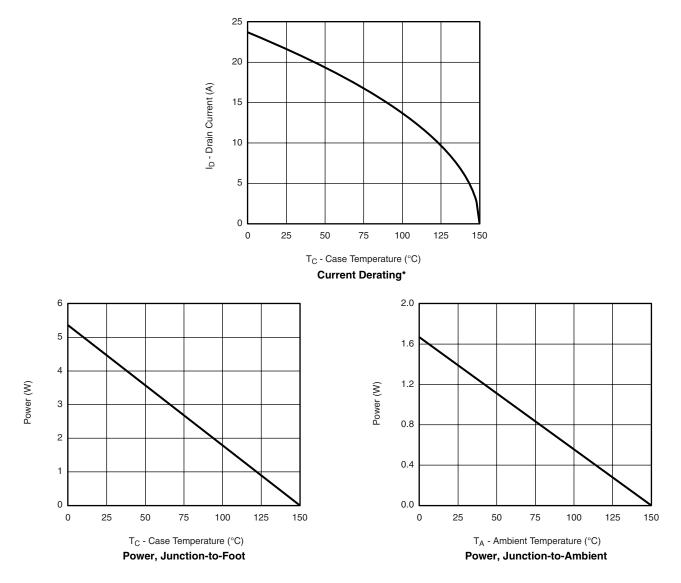








#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



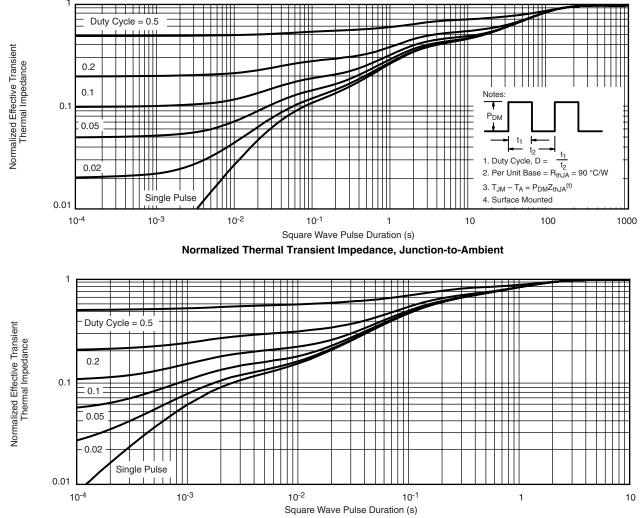
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?70341">www.vishay.com/ppg?70341</a>.



## Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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